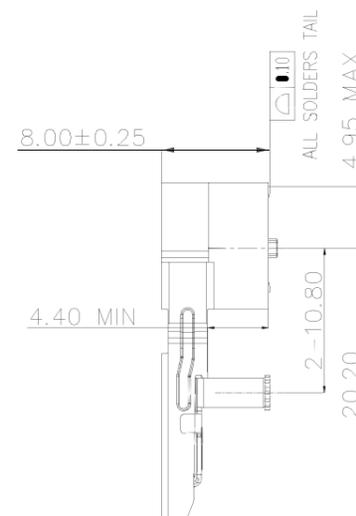
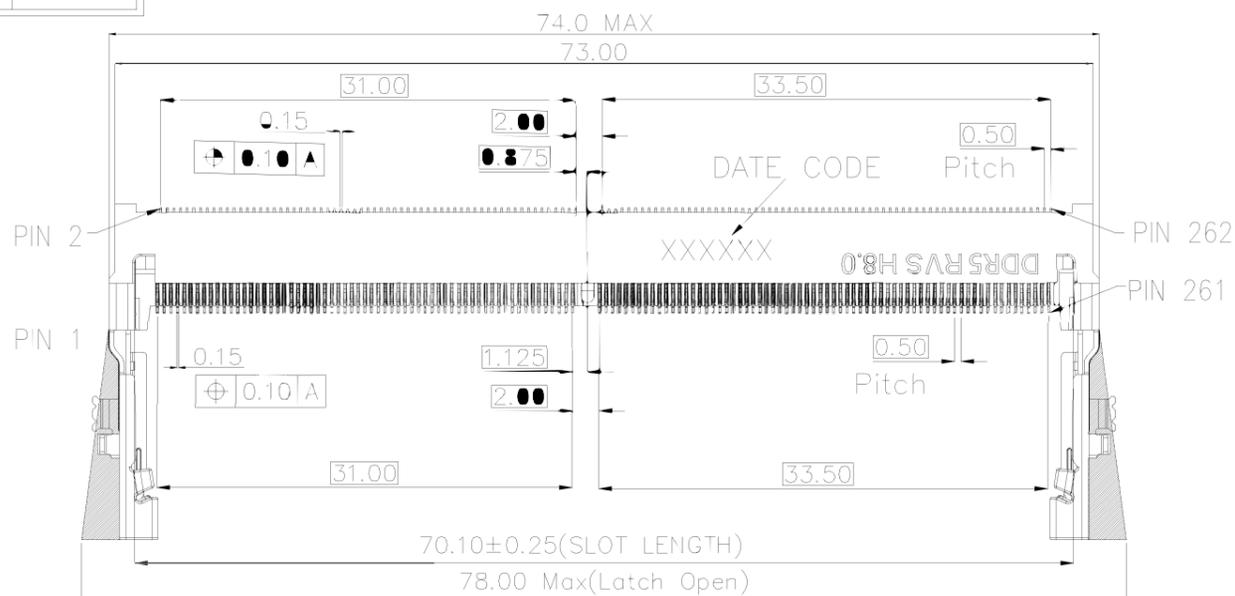


RoHS Compliant HF

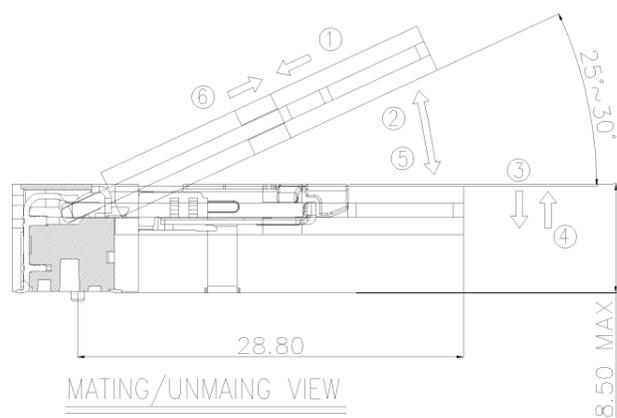
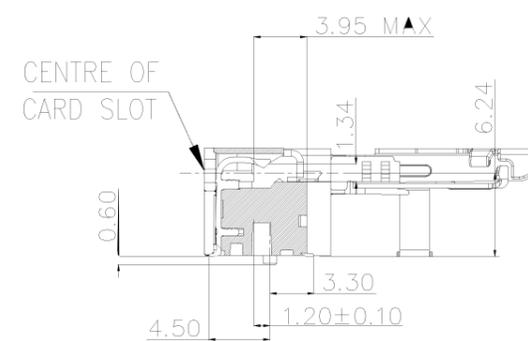
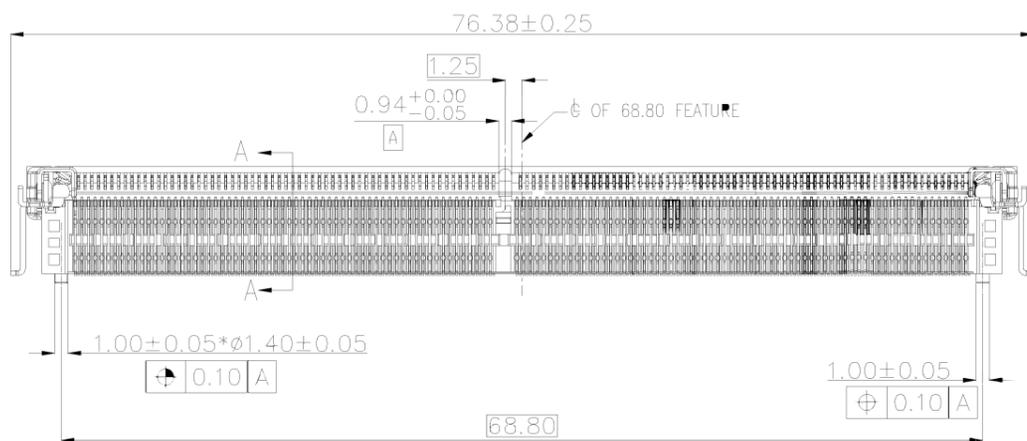
REV.	ECN.NO.	MODIFY.CONTENT
A		NEW
B	N23060601	CHANGE LATCH AND FIXED



NOTES:
 1.FINISH:
 1.1 CONTACT:50u" MIN NICKEL UNDERPLATED ALL OVER.
 GOLD FALSH PLATING ON SOLDER PAIL.
 GOLD PLATING (THICKNESS SEE P/N)NO CONTACT AREA.
 1.2 SOLDER PEG:
 50u"MIN NICKEL UNDERPLATED ALL OVER.
 100u"MIN MATTE TIN PLATING ENTIRE OVER.
 2.DATE CODE:YYWDLX.
 YY:YEAR(20:2020)
 MM:MONTH(01:JANUARY)
 DD:DAY(1~31)
 3.RECOMMENDED STENCIL THICKNESS:0.12mm MIN

PART.NO.:
 DDR006-S5401-**

- 08: 1U"
- 09: 3U"
- 10: 5U"
- 11: 10U"
- 12: 15U"
- 13: 30U"

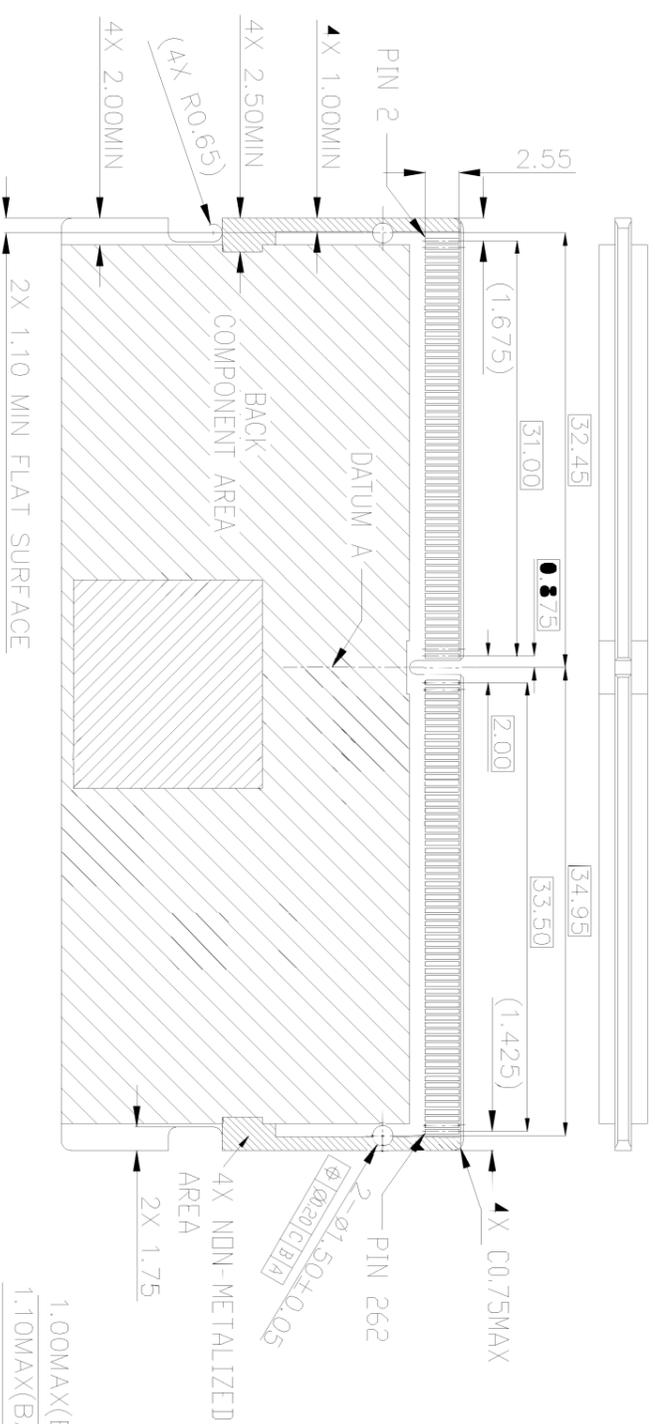
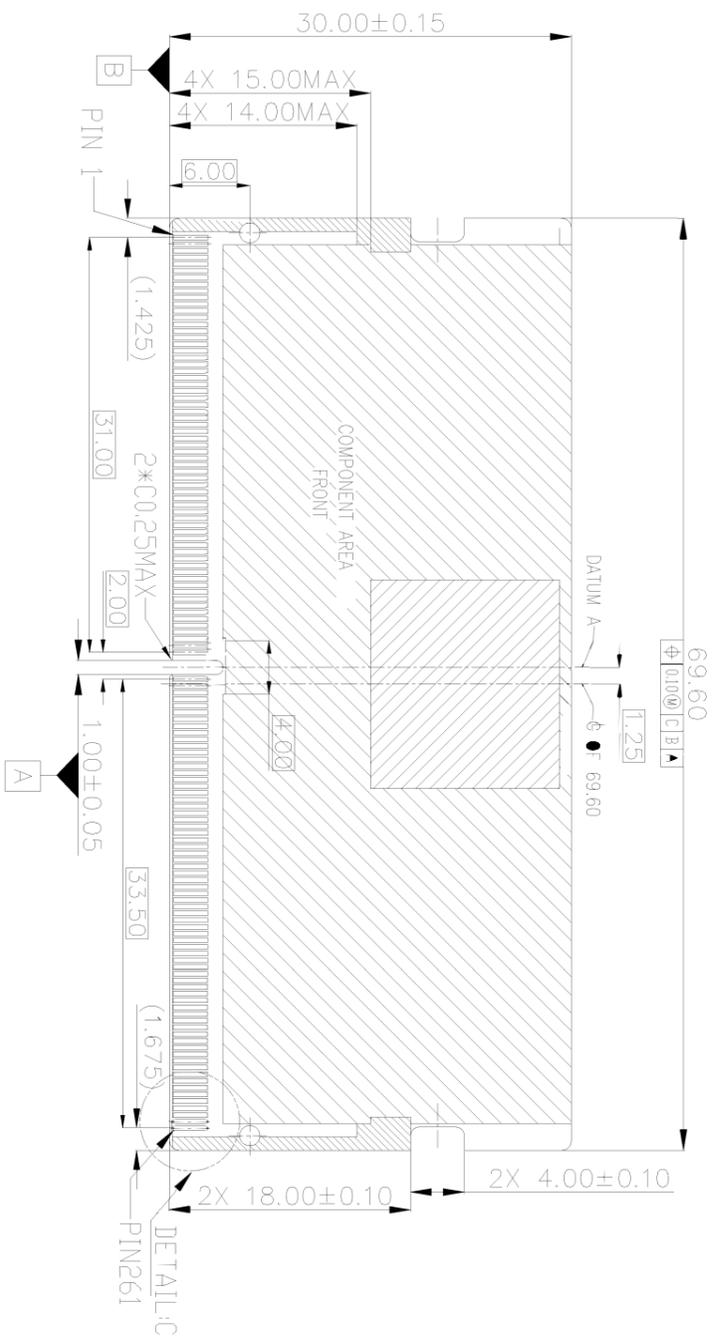


MATING:① INSETING(25) → ② ROTATING → ③ FIXED
 UNMATING:④ INSETING(25) → ⑤ ROTATING → ⑥ WITH DRAWING

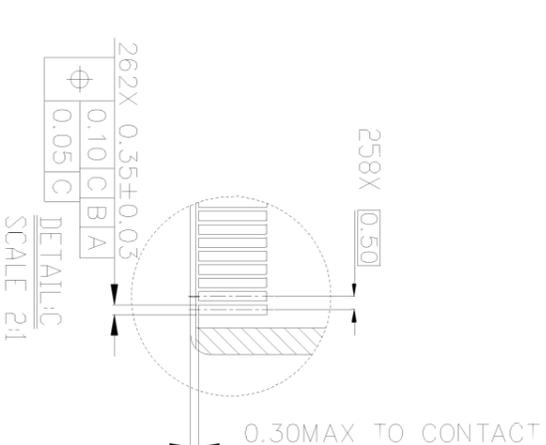
G	FIXED-B	1	SUS304 0.35T	Matt Tin plating All Over 120u"Min
F	FIXED-A	1	SUS304 0.35T	
E	LATCH-B	1	SUS304 0.35T	Clear
D	LATCH-A	1	SUS304 0.35T	
C	TERMINAL-B	131	C5210 0.15T	Contact area gold plating Solder TAIL G/F Ni 50u"Min Underplate
B	TERMINAL-A	131	C5210 0.15T	
A	HOUSING	1	LCP,UL94V-0	BLACK.
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

GENERAL TOLERANCE	TOLERANCE	DWG.NO.	DDR006-S5401-**	PART.NO.	DDR006-S5401-**	DRAWN	DU 2023-06-06	UNIT	mm	SCALE	NO SCALE
x.±0.50	x.°± 5°	REV.	B	TITLE	DDR5 SO DIMM 262Pin(RVS) H8.0	CHECKED		 东莞市欧联电子科技有限公司 DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.			
.x±0.25	.x°± 2°	SIZE		SHEET	1 OF 4	APPROVED					
.xx±0.15	.xx°± 1°	A4									

REV.	ECH.NO.	MODIFY.CONTENT
A		NEW
B	N23060601	CHANGE LATCH AND FIXED



- NOTES:
- 1.DIMENSIONING AND TOLERANCING PER ASME Y14.5-2009.
 2. TOLERANCES ON ALL DIMENSIONS 0.15 UNLESS OTHERWISE SPECIFIED.
 - 3.ALL DIMENSIONS ARE MM.
 - 4.RECOMMENDED PLATING FOR CONTACT PADS ARE:
 - 1) VARIATION xxAX: GOLD PLATING 0.76 MICROMETERS MINIMUM OVER 2.00 MICROMETERS MINIMUM NICKEL.
 - 2) VARIATION xxBx: GOLD PLATING 0.05 MICROMETERS MINIMUM OVER 0.25 MICROMETERS MINIMUM PALLADIUM OVER 2.00 MICROMETERS MINIMUM NICKEL
 - 3) VARIATION xxCx: GOLD PLATING 0.05 MICROMETERS MINIMUM OVER 2.00 MICROMETERS MINIMUM NICKEL.
- MODULE PLATING RECOMMENDATIONS TESTED PER INDUSTRY STANDARD EIA 364-1000. RELIABILITY TESTING REQUIRES TEST MODULE,CONNECTOR, AND IDENTIFICATION OF TEST CONDITIONS.

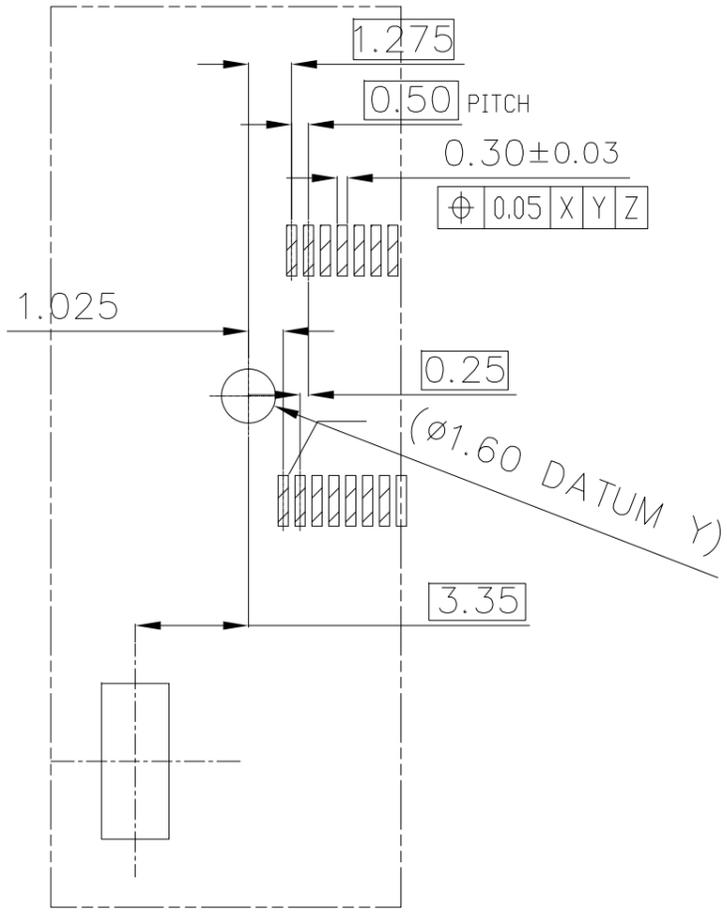
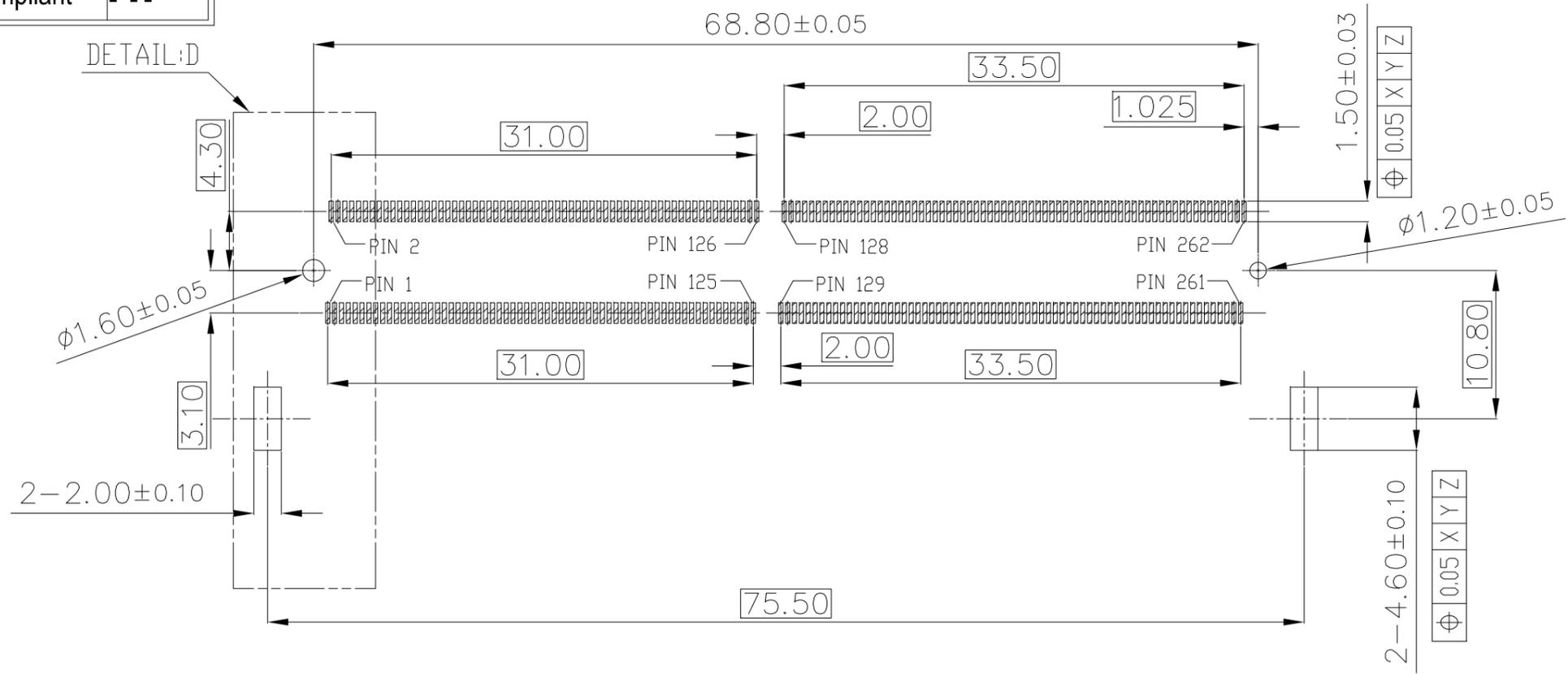


GENERAL	TOLERANCE	DWG.NO.	DDR006-SS401-xx	PART.NO.	DDR006-SS401-xx	DRAWN	DU 2023-06-06	UNIT	mm	SCALE	ND SCALE
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x.±0.50	x.± 5°	REV.	B	TITLE	DDR5 S0 DIMM 262Pin(RVS) H8.0	CHECKED		<p>OLN 东莞市欧联电子科技有限公司 DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.</p>
.x±0.25	.x.± 2°	SIZE	A4	SHEET	2 OF 4	APPROVED		
.xx±0.15	.xx± 1°							

RoHS Compliant HF

REV.	ECN.NO.	MODIFY.CONTENT
A		NEW
B	N23060601	CHANGE LATCH AND FIXED



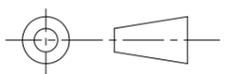
DETAIL:D
SCALE 2:1



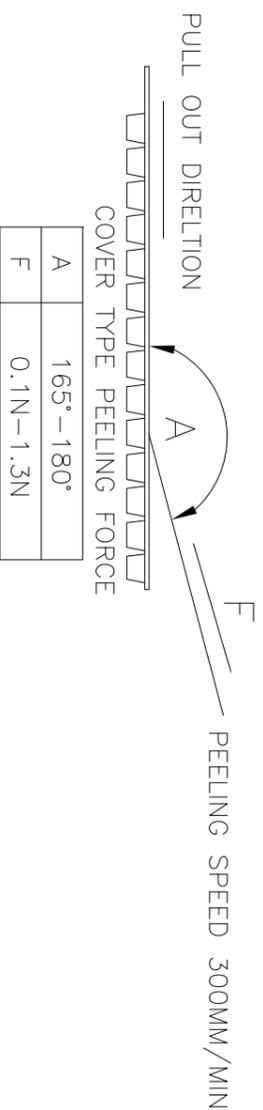
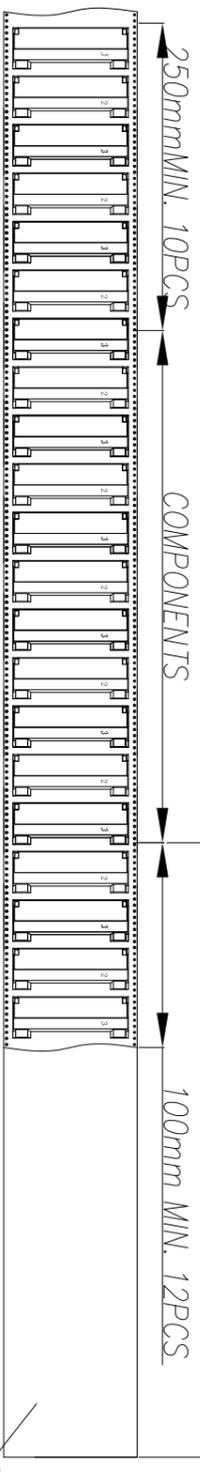
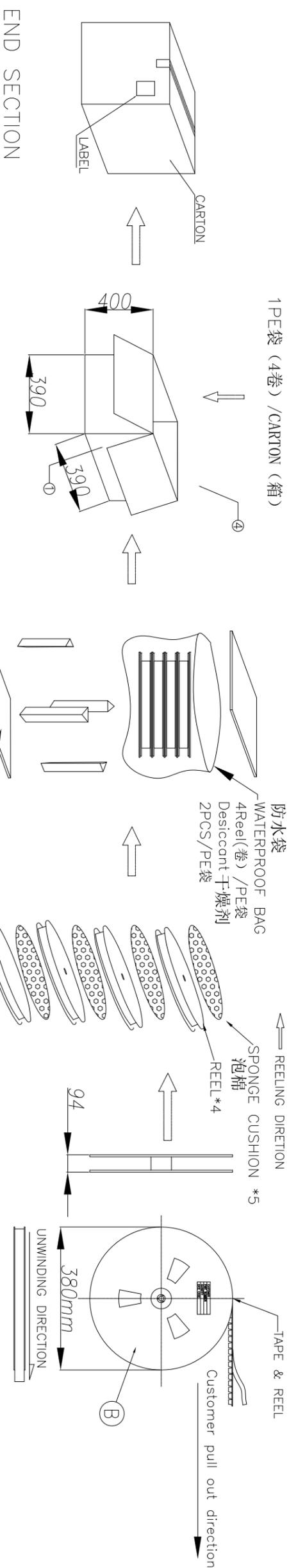
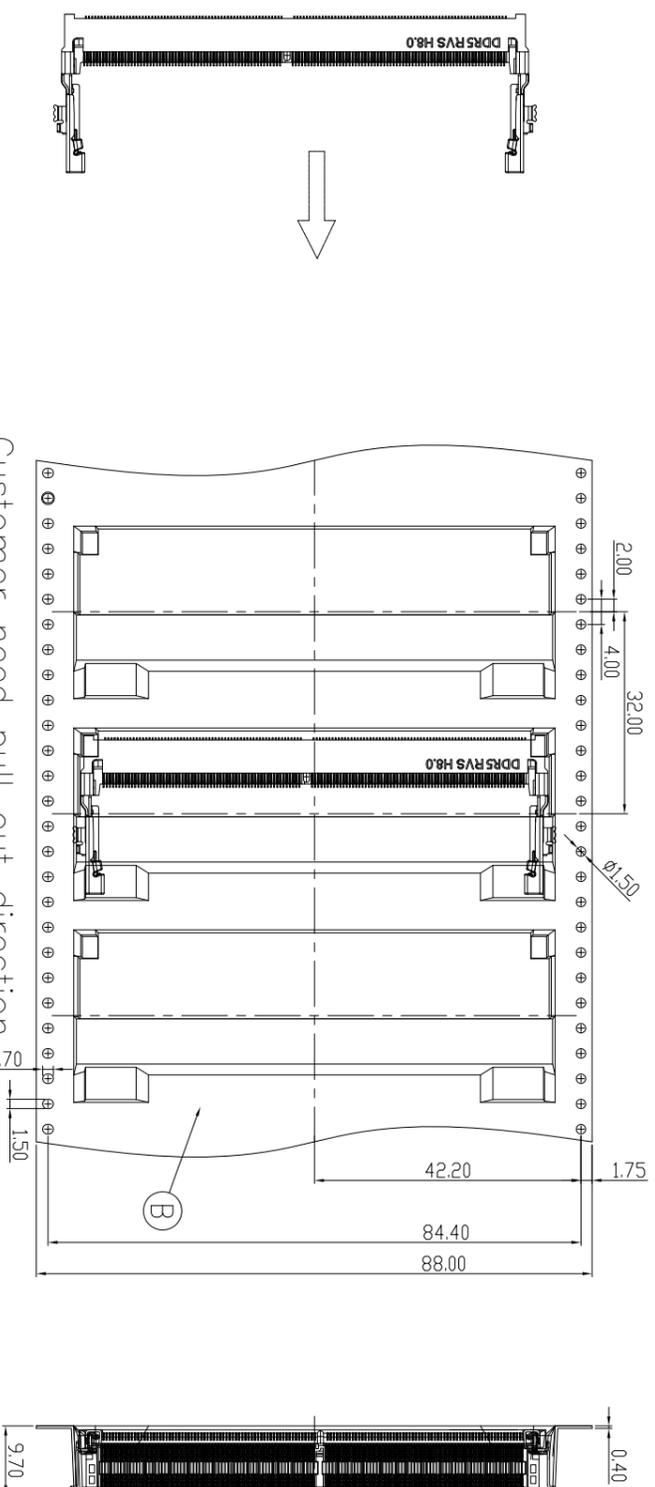
RECOMMEND PCB LAYOUT

THE TOLERANCE UNLESS SPECIFIED IS ±0.05 MM

 Solder pad area

GENERAL TOLERANCE		DWG.NO.	DDR006-S5401-**	PART.NO.	DDR006-S5401-**	DRAWN	DU 2023-06-06	UNIT	mm	SCALE	NO SCALE
x.±0.50	x.°± 5°	REV.	B	TITLE	DDR5 SO DIMM 262Pin(RVS) H8.0	CHECKED		 东莞市欧联电子科技有限公司 DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.			
.x±0.25	.x°± 2°	SIZE		SHEET	3 OF 4	APPROVED					
.xx±0.15	.xx°± 1°	A4									

REV.	ECN.NO.	MODIFY CONTENT
A		NEW
B	N23060601	CHANGE LATCH AND FIXED



- NOTES:
- Quantity: 280PCS/Reel
 - 4 Reel/Carton: 1120 PCS/Carton
 - Each plate needs vacuum packaging, and 2PCS desiccant is placed in the packaging bag

ITEM	MATERIAL	Q'TY	NOTE
⑤	WATERPROOF BAG	1	
④	SUPPORT BRACE	4	
③	REEL ASS'Y	4	
②	CARRIER TAPE	4	
①	CARTON	1	

GENERAL	TOLERANCE	DWG.NO.	DDR006-SS401-**	PART.NO.	DDR006-SS401-**	DRAWN	DU	2023-06-06
X.±0.50	X.±5°	REV.	B	TITLE	DDR5 S0 DIMM 262Pin(RVS) H8.0	CHECKED		
X.±0.25	X.±2°	SIZE	A4	SHEET	4 DF 4	APPROVED		
.XX±0.15	.XX±1°							

UNIT: mm SCALE: ND SCALE

OLN 东莞市欧联电子科技有限公司
DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.